
**Information technology — UPnP
Device Architecture —**

**Part 24-3:
Internet gateway device control
protocol — Level 2 — Wide area
network device**

Technologies de l'information — Architecture de dispositif UPnP —

*Partie 24-3: Protocole de contrôle de dispositif de passerelle
Internet — Niveau 2 — Dispositif de réseau étendu*



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ISO/IEC 29341-24-3 was prepared by UpnP Forum and adopted, under the PAS procedure, by joint technical committee ISO/IEC JTC 1, *Information technology*, in parallel with its approval by national bodies of ISO and IEC.

The list of all currently available parts of ISO/IEC 29341 series, under the general title *Information technology — UPnP Device Architecture*, can be found on the [ISO web site](#).

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